

# PNA1605F (PN116)

## Silicon NPN Phototransistor

For optical control systems

### ■ Features

- High sensitivity
- Wide directional sensitivity, matched to GaAs LEDs :  $\theta = 70$  deg. (typ.)
- Fast response :  $t_r, t_f = 8 \mu\text{s}$  (typ.)
- Side-view type package

### ■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to emitter voltage	$V_{CEO}$	20	V
Collector to base voltage	$V_{CBO}$	30	V
Emitter to collector voltage	$V_{ECO}$	5	V
Emitter to base voltage	$V_{EBO}$	5	V
Collector current	$I_C$	10	mA
Collector power dissipation	$P_C$	100	mW
Operating ambient temperature	$T_{opr}$	-25 to +85	°C
Storage temperature	$T_{stg}$	-30 to +100	°C

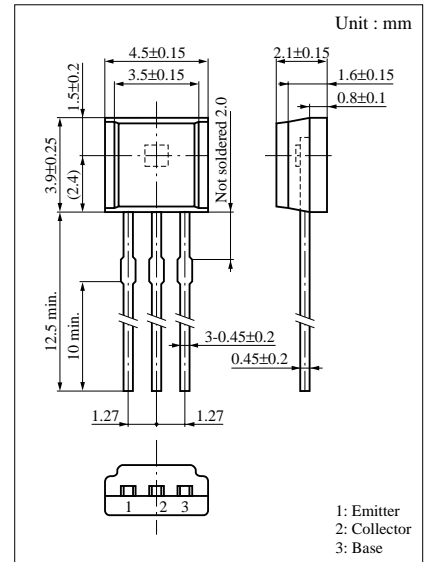


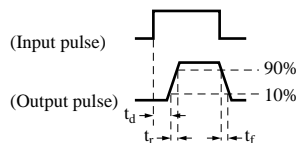
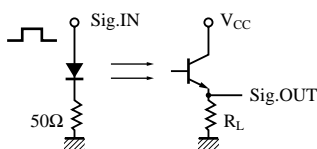
Photo-detectors

### ■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Dark current	$I_{CEO}$	$V_{CE} = 10V$		0.05	2	$\mu\text{A}$
Collector photo current	$I_{CE(L)}$	$V_{CE} = 10V, L = 100 \text{ lx}^{*1}$	0.2	0.8		mA
Peak sensitivity wavelength	$\lambda_P$	$V_{CE} = 10V$		900		nm
Acceptance half angle	$\theta$	Measured from the optical axis to the half power point		70		deg.
Rise time	$t_r^{*2}$	$V_{CC} = 10V, I_{CE(L)} = 1\text{mA}$ $R_L = 100\Omega$		8		$\mu\text{s}$
Fall time	$t_f^{*2}$			9		$\mu\text{s}$
Collector saturation voltage	$V_{CE(sat)}$	$I_{CE(L)} = 1\text{mA}, L = 1000 \text{ lx}^{*1}$		0.3	0.6	V

\*1 Measurements were made using a tungsten lamp (color temperature T = 2856K) as a light source.

\*2 Switching time measurement circuit

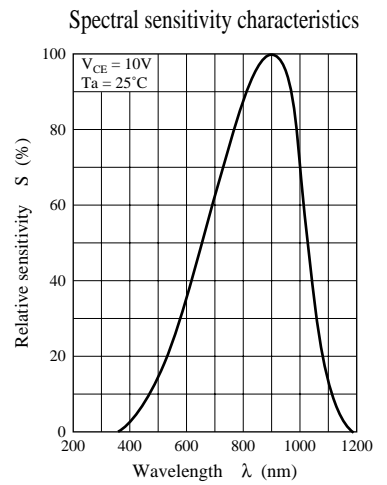
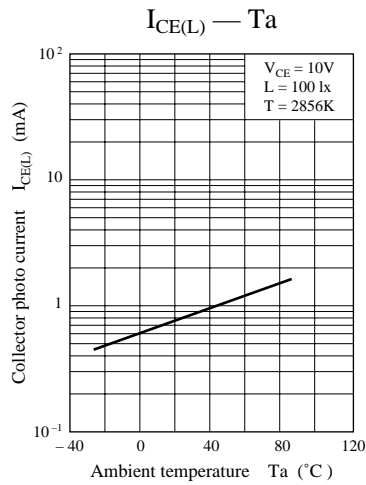
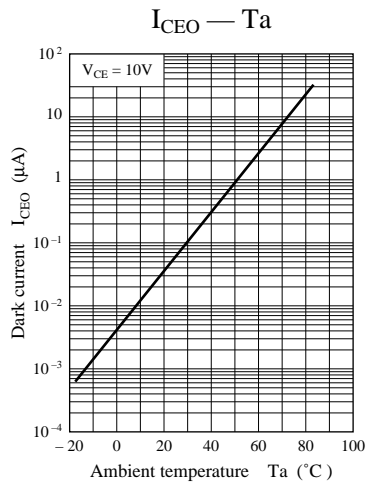
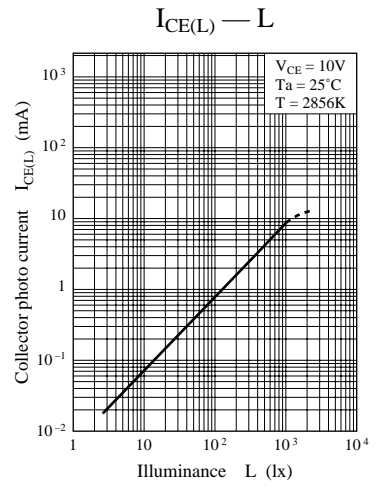
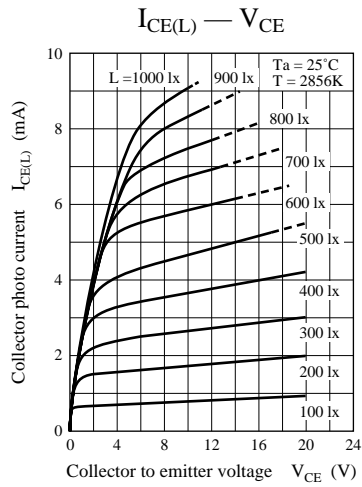
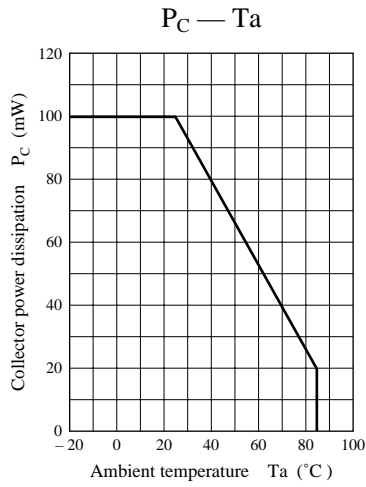


$t_d$ : Delay time

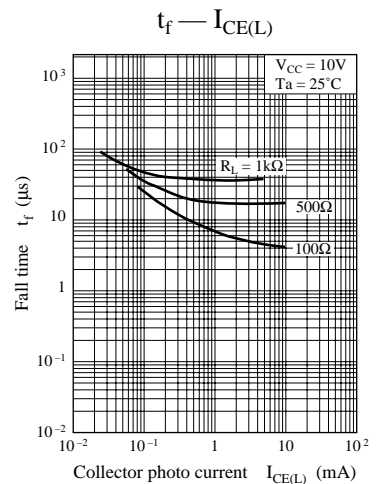
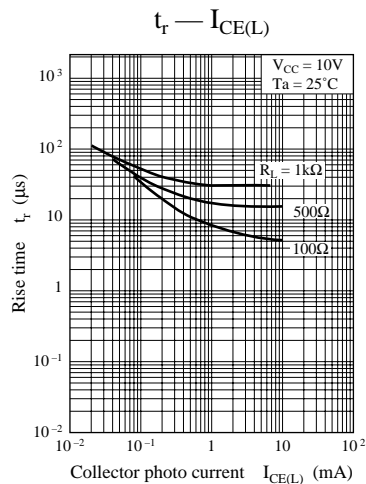
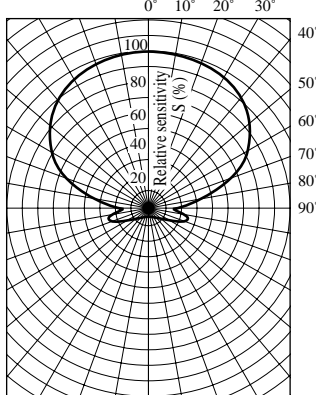
$t_r$ : Rise time (Time required for the collector photo current to increase from 10% to 90% of its final value)

$t_f$ : Fall time (Time required for the collector photo current to decrease from 90% to 10% of its initial value)

Note) The part number in the parenthesis shows conventional part number.



**Directivity characteristics**



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